

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Arvind K. Sinha</td> <td>06/20/2008</td> </tr> <tr> <td>Thomas S. Thompson</td> <td>06/20/2008</td> </tr> </tbody> </table>		Name	Execution Date	Arvind K. Sinha	06/20/2008	Thomas S. Thompson	06/20/2008
Name	Execution Date						
Arvind K. Sinha	06/20/2008						
Thomas S. Thompson	06/20/2008						
RECEIVING PARTY DATA							
Name:	International Business Machines Corporation						
Street Address:	New Orchard Road						
City:	Armonk						
State/Country:	NEW YORK						
Postal Code:	10504						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12143540</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12143540		
Property Type	Number						
Application Number:	12143540						
CORRESPONDENCE DATA							
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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NAME OF SUBMITTER:	Sean Patrick Suiter						
Total Attachments: 2 source=ROC920080281US1Assignment#page1.tif source=ROC920080281US1Assignment#page2.tif							

CH \$40.00 12143540

ASSIGNMENT

Whereas, we,

(1) ARVIND K. SINHA
County of OLMSTED

of ROCHESTER
and State of MINNESOTA

(2) THOMAS S. THOMPSON
County of WABASHA

of LAKE CITY
and State of MINNESOTA

have invented certain improvements in

**METHOD AND APPARATUS OF CHANGING PCB PAD STRUCTURE TO INCREASE
SOLDER VOLUME AND STRENGTH**

and executed, respectively, a United States patent application therefore on

(Dates Inventors Signed Declaration) (1) 6/20, (2008); (2) 6/20, (2008).

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and in all foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

ROC920080281US1

(1) Signed at Rochester, MN on 6/20, 2008.
(City) (Date)

Arvind K. Sinha
ARVIND K. SINHA

(2) Signed at ROCHESTER MN on 20 JUNE, 2008.
(City) (Date)

Thomas S. Thompson
THOMAS S. THOMPSON